# Low-Noise Wideband Transimpedance Amplifier

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*Abstract***—This document presents the design process for a signal path in photosensing applications and develops an approach to easily compare solutions.**

# A) INTRODUCTION

HIS document explores the limits of noise minimization in wideband photosensing applications. It highlights transimpedance challenges and common practices for balancing gain, noise, and bandwidth. T

# B)DESIGN STEPS

The design process is ordered chronologically to emphasize certain parameters and or decisions.

#### *A. System Architecture*

Photosensing applications range widely in performance, making it difficult to find a one-solution fits all. Across several papers, favorable practices included regulated cascodes stages and bootstrapping stages. Ultimately a source follower bootstrap was chosen based on the noise figure.



*Figure 1: Top Level Architecture*

The top level specifications are provided as a reference.



*B. BJT vs. MOSFET*



*Figure 2: TIA Noise Contributions*

The first major design decision should be choosing the TIA technology, primarily BJT or MOSFET. Texas Instruments' document [Transimpedance Considerations for High-Speed](http://www.ti.com/litv/pdf/sboa122)  [Amplifiers](http://www.ti.com/litv/pdf/sboa122) solves this question. By minimizing the inputreferred noise current, an appropriate transimpedance gain threshold is determined. c

$$
i_{n,in} = \sqrt{i_n^2 + \frac{4kT}{R_f} + \left(\frac{e_n}{R_f}\right)^2 + \frac{(e_n \cdot 2\pi f_{enb}C_{in})^2}{3}}
$$
(1)  

$$
R_f = \sqrt{\frac{e_{n(FET)}^2 - e_{n(BJT)}^2}{i_n^2(_{BJT)} - i_n^2(_{FET}) + \frac{2\pi f_{enb}C_{in}}{3}(C_{in_{(BJT)}}e_{n_{(BJT)}}^2 - C_{in_{(FET)}}e_{n_{(FET)}}^2)}
$$
(2)

The paper compares [OPA846](https://www.ti.com/product/OPA846) (BJT) and [OPA657](https://www.ti.com/product/OPA657) (FET). Note, thresholds will vary among different devices but will yield similar conclusions because the order of magnitudes for each technology is consistent.



Solving for  $R_f$ , the total input-referred noise is lower for the FET for any gain greater than  $2k\Omega$ . Further generalizations can be made that FETs are capable of higher transimpedance gain, whereas BJTs have greater bandwidth but limited gain. This relationship is seen in the following figure.



From the figure, some of the application requirements can be realized. The 1 MHz bandwidth is easily achievable among many devices, however the  $1000K$ gain is not possible for all BJTs, including [OPA846.](https://www.ti.com/product/OPA846) Due to the noise and gain requirements, a MOSFET is necessary for the design. Since the paper was written, a performance upgrade to **OPA818** has been released and is also considered in the design.

Highlights of the upgraded amplifier include much lower voltage noise density and lower input capacitance.



# *C. Input-Referred Noise*



As previously mentioned, MOSFETs will yield lower inputreferred noise. In the design process, the TIA is analyzed in a single stage to understand its performance and discover how far it is from the noise target. From the specifications, the tolerated input-referred noise can be determined.

$$
F = 1 + i_{n,in}^{2} / i_{ns}^{2}
$$
\n
$$
= \sqrt{2\pi i - 0.8 \text{ m A} / i \sqrt{Hz}}
$$
\n(1)

$$
u_{ns} = \sqrt{2qu} - 0.6 \text{ pA}/\sqrt{Hz}
$$
  
(2)  

$$
0.5 = 10 \log_{10} \left(1 + i^2 \frac{1}{2} \ln \left(i^2 \frac{1}{2}\right)\right)
$$
 (3)

$$
1.122 = 1 + i_{n,in}^2 / i_{ns}^2
$$
\n(4)

1.122 = 
$$
\frac{i_{ns}^2 + i_{n,in}^2}{i_{ns}^2} = \frac{i_{n,tot}^2}{i_{ns}^2}
$$
 (5)

$$
i_{n,tot} = \sqrt{1.122 \cdot i_{ns}^2} \tag{6}
$$

$$
i_{n,tot} = 1.06 \cdot i_{ns} \tag{7}
$$

$$
i_{n,tot} = 0.85 \text{ pA}/\sqrt{Hz} \tag{8}
$$

Given the photodiode current, the input shot noise is found to be 0.8  $pA/\sqrt{Hz}$ . Thus, in order to remain under 0.5 dB rms, the total input current to the TIA has to be less than 0.85  $pA/\sqrt{Hz}$ .

# *D. Noise Densities wrt Gain*



In designing transimpedance amplifiers, minimal complexity is desired. The gain of the TIA should be maximized without sacrificing noise performance. Analysis of the TIA transfer function is seen as a  $2<sup>nd</sup>$  order filter multiplied by a gain constant.

$$
\frac{v_o}{i_d} = R_f \frac{\omega_0^2}{s^2 + 2\zeta\omega_0 + \omega_0^2}
$$
 (1)

Thus, full gain of the application is achieved by choosing  $R_f = 1000 K\Omega$ . The input-referred noise is reviewed again to ensure noise has not increased with respect to gain. Ignoring the noise across the input capacitance, the input-referred noise is defined:

$$
\frac{r_d + C_{amp}}{pF} \quad i_{n,in} = \sqrt{i_{ns}^2 + i_{na}^2 + \frac{4kT}{R_f} + \left(\frac{e_n}{R_f}\right)^2} \tag{1}
$$

The photodiode current noise density is 0.8  $pA/\sqrt{Hz}$ regardless of the gain. Likewise, the op amp's current noise is independent of gain. The input-referred thermal noise density and op amp noise are summarized in the table.



Op Amp voltage noise density is related to  $1/R_f$  and thermal noise density is related to  $1/\sqrt{R_f}$ . So choosing  $R_f = 1000 K\Omega$ , meets the gain requirements and improves noise performance.

Note, voltage noise density is not constant due to the feedback components of the TIA. More to come on this later. Assuming constant voltage noise density and signal bandwidth, the output voltage  $rms$  is calculated.

$$
i_{n,tot} = 0.85pA \tag{1}
$$

$$
\frac{e_{n,out}}{R_f} \leq 0.85pA \tag{2}
$$

$$
e_{n,out} = \frac{v_o}{i_{n,tot}} i_{n,tot} \bigg|_{R_t = 1000K} = 850nV/\sqrt{\text{Hz}} \tag{3}
$$

 $850nV/\sqrt{\text{Hz}} \cdot \sqrt{1 \text{ MHz}} = 850uV$  $(4)$ 

# *E. TIA Filter Design*



Previously discussed, the transfer function of the TIA is recognized as a 2<sup>nd</sup> order filter. The application specifies 0  $dB$ peaking in the filter response such that  $\zeta = \frac{1}{\Omega} = 1/\sqrt{2}$ , yielding a Butterworth response. The following values for  $C_f$  and  $f_{3dB}$  are solved using the  $OPA818$  parameters.

$$
\frac{v_o}{i_d} = R_f \frac{\omega_0^2}{s^2 + 2\zeta\omega_0 + \omega_0^2}
$$
 (1)

$$
\omega_t = 2\pi \underbrace{\text{(GBW)}}_{\text{(2)}}
$$

$$
C_f = \sqrt{\frac{2 \cdot C_{in}}{R_f \omega_t}} = 0.13 \text{ pF}
$$
 (3)

$$
\omega_{3dB} = \omega_0 = \sqrt{\frac{\omega_t}{R_f(C_{in} + C_f)}}
$$
\n(4)

$$
f_{3dB} = \omega_{3dB} / (2\pi) = 1.68 \text{ MHz}
$$
 (5)

By enforcing 0  $dB$  peaking, the 3  $dB$  bandwidth is violated with new cutoff frequency of 1.68 MHz. This is not a major design concern since a low pass filter stage can always be added. Also assuming  $C_{in} \gg C_f$ , then the ideal MOSFET with no additional stages would have gain bandwidth of 955 MHz.

# *F. Single Stage AC Analysis*





# *G. Single Stage Noise Performance*



*Figure 5: Single Stage Design*

In this section, noise performance is reviewed to determine the op amp for the application. The input-referred noise and noise figure is plotted for [OPA657](https://www.ti.com/product/OPA657) and [OPA818](https://www.ti.com/product/OPA818?qgpn=opa818).



*Figure 6: TIA Single Stage Noise Figure*







V(onoise)	
Interval Start:	100mHz
Interval End:	1000KHz
Total RMS noise:	1.4405mV

*Figure 8: TIA Single Stage RMS* 

Both amplifiers pass the application specs at low frequencies. However, large peaking occurs around 1 MHz due to the noise transfer function of the TIA. RMS is provided and demonstrates the need to reduce peaking in the signal bandwidth.

The upgraded op amp, OPA818, is clearly the favorite in this design in order to achieve the 0.5  $dB$  noise figure. For applications with lower bandwidths, OPA657 could suffice.

More analysis is needed to understand the peaking effect. The noise gain of the TIA is defined:

$$
\frac{e_{na,in}}{e_{na}} = \left(1 + \frac{Z_f}{Z_{in}}\right) = \frac{1 + s(C_{in} + C_f)R_f}{1 + sC_fR_f}
$$
(1)

Peaking rises with frequencies greater than the zero defined as

$$
Z_1 = \frac{1}{2\pi R_f (C_{in} + C_f)}
$$
 (1)



*Figure 9: Noise Stability Analysis*  $(C_s = C_{in})$ 

To improve noise performance, the input impedance needs to be decreased in order to push the zero to higher frequencies. Assuming  $C_{in} + C_f \approx C_{in}$ , the following table demonstrates this relationship.



# *H. Source Follower Bootstrap*



*Figure 10: Source Follower Bootstrap + TIA*



I found Glen Brisebois' article [Low Noise Amplifiers for](https://www.analog.com/media/en/reference-design-documentation/design-notes/dn399f.pdf)  [Small and Large Area Photodiodes](https://www.analog.com/media/en/reference-design-documentation/design-notes/dn399f.pdf) very helpful.

# *I. Bootstrap + TIA AC Response*

In the filter design section, the cutoff frequency is defined:

$$
\omega_{3dB} = \omega_0 = \sqrt{\frac{\omega_t}{R_f(C_{in} + C_f)}}
$$
(1)

The bootstrap changes the input impedance seen by the feedback resistor such that it is nearly infinite. The cutoff frequency for this solution is 1.25 MHz.



*Figure 12: Bootstrap and TIA Phase Response*

# *J. Bootstrap + TIA Input Impedance*

Analyzing the input impedance shows how much the noise gain has been improved. The design goal is to decrease input resistance to push the zero frequency beyond the signal bandwidth.



The input resistance at low frequencies is  $0dB = \sim 1\Omega$ . The input impedance  $3$  dB occurs at 37MHz.

# *K.Bootstrap + TIA Noise Response*



*Figure 14: Bootstrap and TIA Input-Referred Noise Response*



The bootstrap almost completely smooths out the peaking seen by the transimpedance amplifier. The feedback resistor now only sees the input resistance and capacitance of the JFET  $(25 pF).$ 







The bootstrap and TIA solution passes the 0.5  $dB$  threshold at 345 kHz. This is still quite far from the 1 MHz signal bandwidth but we have greatly improved from the single stage TIA.



*Figure 16: Bootstrap and TIA RMS* 

# *L. Bootstrap + TIA Transient Signal*



*Figure 17: Transient Response for 2µA Input Pulse* 

The solution is working exactly as intended. It is an inverting amplifier so the output voltage is the inverse of the input. The expected output equals the transimpedance gain multiplied by the input. So  $V_{out} = -1000K \cdot 2\mu A = -2V$ .

#### *M. Application Power*

Total power of the application is 477 mW.

Power Dissipation

Product	$I_{DD}$ (mA)	$V_{\rm CC} + V_{\rm EE}$	#	Power (mW)
<b>TIA OPA818</b>	27.7	$5+5$		277
Bootstrap <b>LSK389A</b>	10	$10+10$		200
Total				477 mW

# *N.Application Costs*

Total sum of the application is  $$0.32 + $7.97 = $8.29$ 

# Bill of materials Components



# Bill of Materials Amplifiers/Transistors



# References

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